			First Edition	Approved by	Production Div.
			Aug 8, 2000	Checked by	Omon Quality Assurance Div.
$\parallel$ L(	CD Module S	Specification	Final Revision		
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Type No.	F-5113	36NCWHU-I	FW-AA	Prepared by	Production Div
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## 1. General Specifications

Operating Temp. : min.  $-30^{\circ}$ C  $\sim$  max.  $85^{\circ}$ C Note 1

Storage Temp. : min.  $-40^{\circ}$ C  $\sim$  max.  $90^{\circ}$ C

Dot Pixels :  $256 \times 3$  [R.G.B] (W)  $\times$  64 (H) dots

Dot Size :  $0.115 \text{ (W)} \times 0.365 \text{ (H)} \text{ mm}$ 

Dot Pitch :  $0.135 \text{ (W)} \times 0.385 \text{ (H)} \text{ mm}$ 

Viewing Area :  $106.66 \text{ (W)} \times 27.62 \text{ (H)} \text{ mm}$ 

Outline Dimensions :  $146.2 \text{ (W)} \times 39.3 \text{ (H)} \times 17.0^* \text{ (D)} \text{ mm}$ 

\* Without Connector

Weight : 144g max.

LCD Type : CTD-17492 / NTX-17493

(D-STN / Color-mode / Transmissive)

Viewing Angle : 12:00

Data Transfer : 8-bit parallel data transfer

Backlight : Cold Cathode Fluorescent Lamp (CFL)  $\times$  1

Drawings : Dimensional Outline UE-300649A

Note 1. This module has the heater built-in for CFL Back Light.

Under the circumstances of using below  $0^{\circ}$ C, the heater for CFL shall be turned on, first. Per confirming the temperature of CFL to be above  $0^{\circ}$ C, the CFL shall be lighten up.

The heater for CFL shall be used as under  $10^{\circ}$ C by controlling the current with a resister value of thermistor on CFL.

A security function on CFL heater drive circuit shall be installed in order to turn off the heater automatically when its temperature is being too high.

# 2. Electrical Specifications

# 2.1. Absolute Maximum Ratings

 $V_{SS}=0V$ 

Parameter	Symbol	Conditions	Min.	Max.	Units
Supply Voltage	V <sub>CC1</sub> -V <sub>SS</sub>	_	-0.3	6.0	V
	Vcc2-Vss				
Supply Voltage	V <sub>CONT</sub> -V <sub>SS</sub>	_	-0.3	6.0	V
(LCD Control)					
Input Voltage	VI	_	-0.3	V <sub>CC1</sub> +0.5	V
Output Voltage	Vo	_	-0.3	V <sub>CC1</sub> +0.5	V

### 2.2.DC Characteristics

Ta=25°C, Vss=0V

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Supply Voltage	V <sub>CC1</sub> -V <sub>SS</sub>	_	4.5	5.0	5.5	V
(Logic)	V <sub>CC2</sub> -V <sub>SS</sub>					
Supply Voltage	V <sub>CONT</sub> -V <sub>SS</sub>	_	0.5	2.5	4.5	V
(LCD Drive)						
High Level	$V_{IH}$	V <sub>CC1</sub> =5.5V	2.0	_	V <sub>CC1</sub>	V
Input Voltage		AB1~15				
Low Level	$V_{\rm IL}$	V <sub>CC1</sub> =4.5V	_	_	0.8	V
Input Voltage		AB1~15				
Positive-going	VT+	_	_	_	2.4	V
Threshold						
Negative-going	VT-	_	0.6	_	_	V
Threshold						
Hysteresis	VH	_	0.1	_	_	V
Voltage						
High Level	Voh	I <sub>OH</sub> =-8mA,	V <sub>CC1</sub> -0.4	_	_	V
Output Voltage		DB0~DB15				
Low Level	$V_{OL}$	I <sub>OL</sub> =8mA,	_	_	0.4	V
Output Voltage		DB0~DB15				
High Level	V <sub>OH</sub>	I <sub>OH</sub> =-12mA,	V <sub>CC1</sub> -0.4	_	_	V
Output Voltage		READY				
Low Level	Vol	IoL=12mA,	_	_	0.4	V
Output Voltage		READY				

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
MCLK	fosc	_	_	4.19	_	MHz
Frequency						
Supply Current Icc Vcc1-Vs		V <sub>CC1</sub> -V <sub>SS</sub> =5.0V	_	50	75	mA
	注 1	V <sub>CC2</sub> -V <sub>SS</sub> =5.0V				

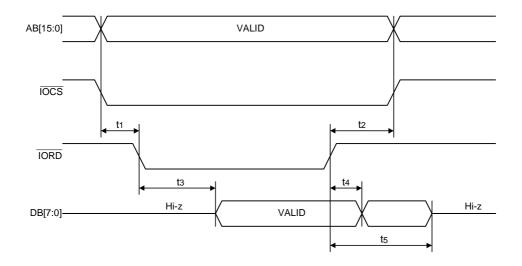
注 1:  $I_{CC} = I_{CC1} + I_{CC2}$ 

## 2.3.AC Characteristics

# 2.3.1.Read/Write Operation Sequence (Non-MC68000)

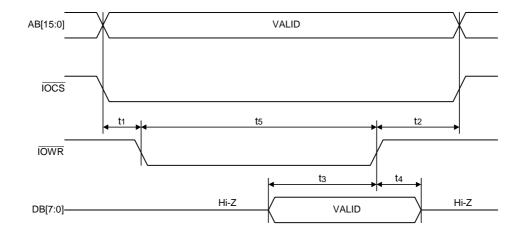
**READ** 

$\frac{\textbf{READ}}{\textbf{VCC1}=4.5\sim5.5}$						
Parameter	Symbol	Min.	Max.	Units		
AB[15:0] and $\overline{\rm IOCS}$ valid before $\overline{\rm IORD}$ $\downarrow$	$t_1$	0		ns		
AB[15:0] and $\overline{\rm IOCS}$ hold from $\overline{\rm IORD}$ $\uparrow$	$t_2$	10	_	ns		
TORD ↓ to DB[7:0] valid	$t_3$	_	40	ns		
DB[7:0] hold from <del>IORD</del> ↑	$t_4$	_	15	ns		
TORD ↑ to DB[7:0] Hi-z delay	$t_5$	_	25	ns		



**WRITE**  $V_{CC1}\!\!=\!\!4.5\!\sim\!\!5.5V$ 

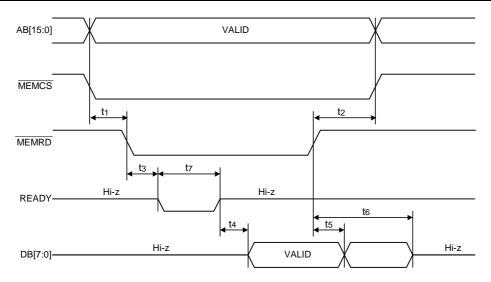
Parameter	Symbol	Min.	Max.	Units
AB[15:0] and $\overline{\rm IOCS}$ valid before $\overline{\rm IOWR} \downarrow$	$t_1$	0		ns
AB[15:0] and <del>IOCS</del> hold from <del>IOWR</del> ↑	$t_2$	10	_	ns
DB[7:0] setup to <del>IOWR</del> ↑	$t_3$	10	_	ns
DB[7:0] hold from <del>IOWR</del> ↑	$t_4$	10	_	ns
Pulse width of TOWR	$t_5$	20	_	ns



## 2.3.2.Read/Write Operation Sequence (VRAM)

 $\underbrace{\textbf{READ}}_{\text{VCC1}=4.5\sim5.5\text{V}}$ 

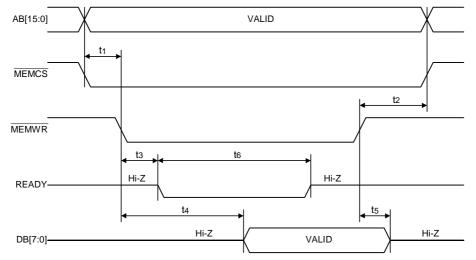
Parameter	Symbol	Min.	Max.	Units
AB[15:0] and MEMCS valid before MEMRD ↓	$t_1$	0	_	ns
AB[15:0] and MEMCS hold from MEMRD ↑	$t_2$	0	_	ns
MEMRD ↓ to READY ↓	$t_3$	_	20	ns
READY ↑ to DB[7:0] valid	$t_4$		10	ns
DB[7:0] hold from MEMRD ↑	$t_5$	_	10	ns
MEMRD↑ to DB[7:0] Hi-z delay	$t_6$	_	20	ns
READY negated pluse width	$t_7$	_	3.5×MCLK+10	ns



Where MCLK=1/fosc or 2/fosc depending on which display mode the chip is in ( See Section 2.3.3 )

WRITE  $V_{CC1}=4.5\sim5.5V$ 

Parameter	Symbol	Min.	Max.	Units
AB[15:0] and $\overline{\text{MEMCS}}$ valid before $\overline{\text{MEMWR}} \downarrow$	$\mathbf{t}_1$	0	_	ns
AB[15:0] and MEMCS hold from MEMWR ↑	$t_2$	0	_	ns
$\overline{\text{MEMWR}} \downarrow \text{ to READY } \downarrow$	$t_3$	_	20	ns
MEMWR ↓ to DB[7:0] valid	$t_4$	_	MCLK-20	ns
DB[7:0] hold from MEMWR ↑	$t_5$	0	_	ns
READY negated pluse width	t <sub>6</sub>	_	35×MC1 K+10	ns



Where MCLK=1/fosc or 2/fosc depending on which display mode the chip is in ( See Section 2.3.3 )

## 2.3.3.SRAM Access Time

## **8-bit Display Memory Interface**

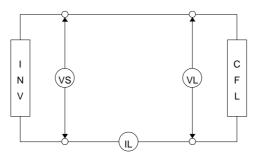
Display Mode	Access Time
16-Level Colors	Access time ≤ 1/fosc-25ns
4-Level Colors	Access time ≤2/fosc-25ns
Black-and-White (BW)	Access time $\leq 2/\text{fosc-}25\text{ns}$

#### 2.4. Lighting Specifications

Ta=25°C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units	Notes
Lamp Voltage	$V_{L}$	I <sub>L</sub> =5mA	340	380	420	Vrms	1
Lamp Current	IL	_	4.5	5.0	5.5	mArms	2
Starting Voltage	Vs	Ta=25°C	_	_	650	Vrms	3
		Ta=0°C	_	_	870	Vrms	3
Surface Luminance	L	IL=5mA	_	150	_	cd/m²	4
Average Life	Tal	IL=5mA	10000	25000	_	hrs	5

- Note 1 : The voltage (r.m.s.) to maintain the electric discharge of the lamp. It is measured after lighting for 3 minutes .
- Note 2 : The current (r.m.s.) to flow through the lamp with the electric discharge. It is measured after lighting for 3 minutes.
- Note 3: The voltage at starting the electric discharge when the voltage is increased gradually from 0V.
- Note 4 : Surface Luminance is specified by the initial data of luminance measured at the center of display surface after 20 minutes power on. ( All ON pattern )
- Note 5 : CFL life is defined as the time for which the initial luminance is attenuated by 50% of the luminance value. Average Life representes the time elapsed at the point of time when the residual ratio becomes below 50% when plural lamps are lighted in comparison with the definition of life mentioned above.



**CFL Testing Circuit** 

### 2.5. Heater Specifications

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Heater Voltage	HVDD	_	_	12	14	V
Heater Power	HP	_	_	4.75	6.5	W
Resistor Value of Thermistor	RTH	_	11.03	10.31	9.58	ΚΩ
Resistor Value of Thermistor	BTH	_	3411	3480	3549	K
Constant B						

## 3. Optical Specifications

#### 3.1. Optical Characteristics

Ta=25°C, 1/64 Duty, 1/9 Bias,  $V_D$ =17.7V (Note 4),  $\theta = 0^{\circ}$ ,  $\phi = -^{\circ}$ 

Parameter Symbol			Conditions	Min.	Тур.	Max.	Units
Contrast Ratio Note 1		CR	$\theta = 0^{\circ}$ , $\phi = -^{\circ}$	_	70	_	
Chromaticity (white)		X	_	0.302	0.327	0.352	
	Note 2		_	0.301	0.326	0.351	
Viewing An	gle		Shown in 3.3				
	Rise Note 3	Ton	Ta=25°℃	_	210	320	ms
Response	Decay Note 4	Toff	Ta=25℃	_	80	160	ms
Time	Rise Note 3	Ton	Ta=-30°C	_	11000	16500	ms
	Decay Note 4	Toff	Ta=-30°C	_	3300	5000	ms

Note 1: Contrast ratio is definded as follows.

 $CR = L_{ON} / L_{OFF}$ 

Lon: Luminance of the ON segments Loff: Luminance of the OFF segments

Note 2 : Bucklight Surface Chromaticity : x=0.348, y=0.349

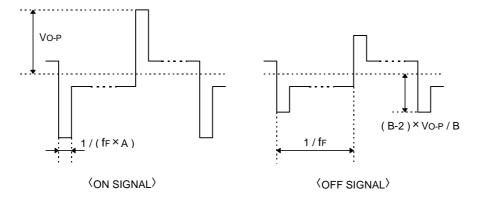
Note 3: The time that the luminance level reaches 90% of the saturation level from 0% when ON signal is applied.

Note 4: The time that the luminance level reaches 10% of the saturation level from 100% when OFF signal is applied.

Note 5 : Definition of Driving Voltage  $V_D$ 

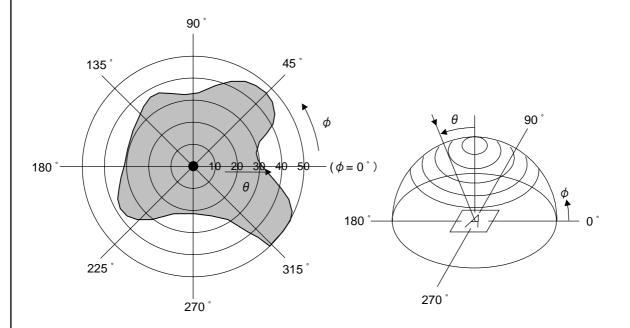
V<sub>D</sub>=V<sub>CC</sub>-V<sub>ADJ</sub>-V<sub>BE</sub>

Assuming that the typical driving waveforms shown below are applied to the LCD Panel at 1/A Duty - 1/B Bias ( A: Duty Number, B: Bias Number ). Driving voltage  $V_D$  is definded as the voltage  $V_{O-P}$  when the contrast ratio (CR= $L_{ON}$  /  $L_{OFF}$ ) is at its maximum.



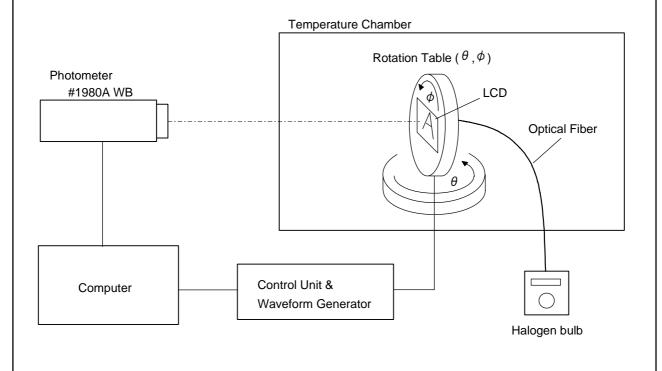
## 3.2. Definition of Viewing Angle and Optimum Viewing Area

- •Point  $\bullet$  shows the point where contrast ratio is measured. :  $\theta = 0^{\circ}$ ,  $\phi = -^{\circ}$
- · Driving condition : 1/64 Duty, 1/9 Bias,  $V_D=17.7V$ ,  $f_F=140Hz$



·Area shows typ. CR≥10

## 3.3.System Block Diagram



# 4.<u>I/O Terminal</u>

# 4.1.Pin Assignment

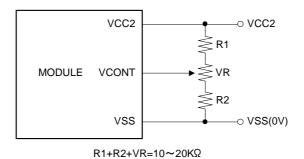
CN1

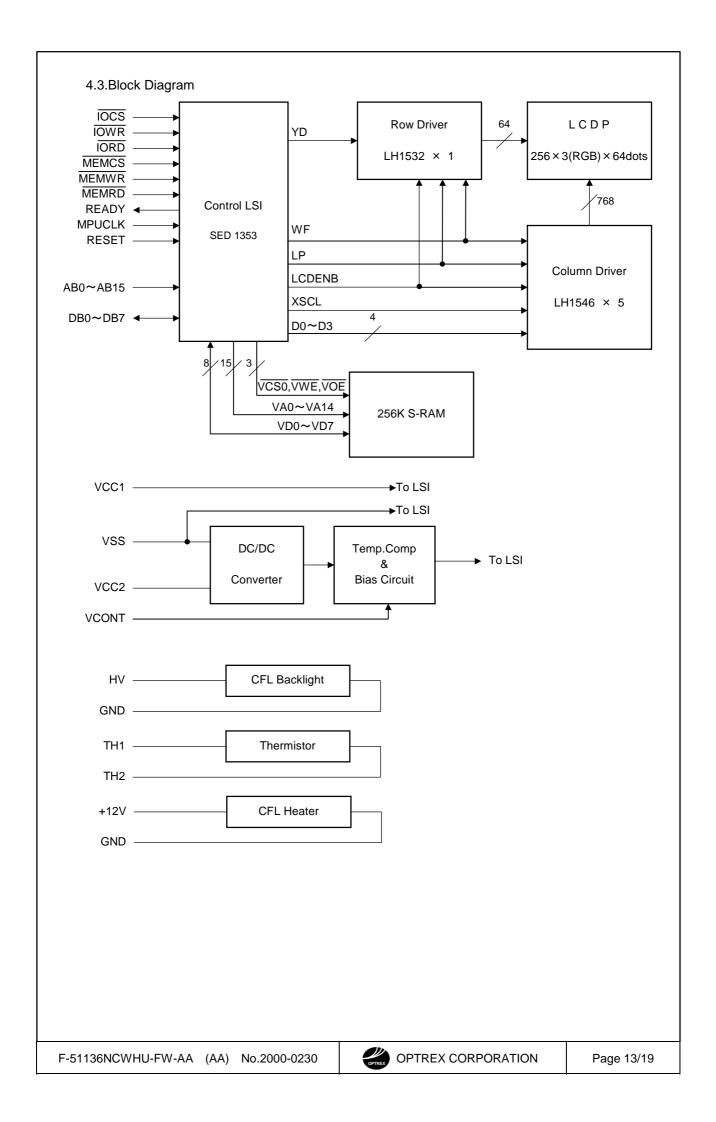
No.	Symbol	Level	Function
1	FG	_	Frame Ground
2	Vss	_	Power Supply (0V, GND)
3	Vss	_	Power Supply (0V, GND)
4	V <sub>CC1</sub>	_	Power Supply for Logic
5	V <sub>CC1</sub>	_	Power Supply for Logic
6	V <sub>CC2</sub>	_	Power Supply for LCD Drive
7	V <sub>CC2</sub>	_	Power Supply for LCD Drive
8	VCONT	_	Power Supply for LCD Control
9	ĪOCS	H/L	Control register, Chip Select L: Active
10	ĪOWR	H/L	Control register, Write Enable L: Active
11	ĪODR	H/L	Control register, Read Enable L: Active
12	MEMCS	H/L	VRAM. Chip Select L: Active
13	MEMWR	H/L	VRAM. Write Enable L: Active
14	MEMRD	H/L	VRAM. Read Enable L: Active
15	READY	H/L	Ready Signal
16	RESET	H/L	Reset Signal L: Reset
17	AB0	H/L	Adress Bus Line
18	AB1	H/L	Adress Bus Line
19	AB2	H/L	Adress Bus Line
20	AB3	H/L	Adress Bus Line
21	AB4	H/L	Adress Bus Line
22	AB5	H/L	Adress Bus Line
23	AB6	H/L	Adress Bus Line
24	AB7	H/L	Adress Bus Line
25	AB8	H/L	Adress Bus Line
26	AB9	H/L	Adress Bus Line
27	AB10	H/L	Adress Bus Line
28	AB11	H/L	Adress Bus Line
29	AB12	H/L	Adress Bus Line
30	AB13	H/L	Adress Bus Line
31	AB14	H/L	Adress Bus Line
32	AB15	H/L	Adress Bus Line
33	DB0	H/L	Data Bus Line
34	DB1	H/L	Data Bus Line
35	DB2	H/L	Data Bus Line

36	DB3	H/L	Data Bus Line		
37	DB4	H/L	Data Bus Line		
38	DB5	H/L	Data Bus Line		
39	DB6	H/L	Data Bus Line		
40	DB7	H/L	Data Bus Line		
CN2		•	•		
No.	Symbol	Level	Function		
1	HV	_	Power Supply for CFL (High Voltage)		
2	NC	_	Non-connection		
3	NC	_	Non-connection		
4	GND	_	Power Supply for CFL (GND)		
CN3		•			
No.	Symbol	Level	Function		
1	TH1	_	Themister Terminal		
2	TH2	_	Themister Terminal		
3	+12V	_	Power Supply for CFL Heater ( +12V )		
4	GND	_	Power Supply for CFL Heater ( GND )		

## 4.2. Example of Power Supply

It is recommended to apply a potentiometer for the contrast adjust due to the tolerance of the driving voltage and its temperature dependence.





# 5.Test

No change on display and in operation under the following test condition.

No.	Parameter	Conditions	Notes
1	High Temperature Operating	$85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ , 96hrs (operation state)	
2	Low Temperature Operating	-30°C ±2°C, 96hrs (operation state)	3
3	High Temperature Storage	90°C ±2°C, 96hrs	4
4	Low Temperature Storage	-40°C ±2°C, 96hrs	3, 4
5	Damp Proof Test	60°C±2°C, 85∼90%RH, 96hrs	3, 4
6	Vibration Test	Total fixed amplitude: 1.5mm	5
		Vibration Frequency : 10∼55Hz	
		One cycle 60 seconds to 3 directions of X, Y, Z for	
		each 15 minutes	
7	Shock Test	To be measured after dropping from 60cm high on	
		the concrete surface in packing state.	
		Dropping method corner dropping A corner : once  Edge dropping B,C,D edge : once Face dropping E,F,G face : once	

Note 1: Unless otherwise specified, tests will be conducted under the following condition.

Temperature :  $20\pm5^{\circ}$ C Humidity :  $65\pm5\%$ 

Note 2: Unless otherwise specified, tests will be not conducted under functioning state.

Note 3: No dew condensation to be observed.

Note 4: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.

Note 5: Vibration test will be conducted to the product itself without putting it in a container.

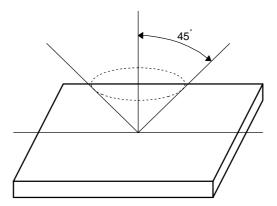
# 6. Appearance Standards

### 6.1.Inspection conditions

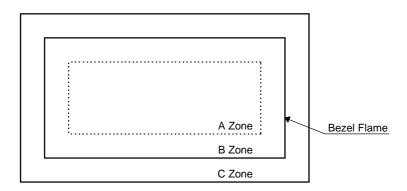
The LCD shall be inspected under 40W white fluorescent light.

The distance between the eyes and the sample shall be more than 30cm.

All directions for inspecting the sample should be within 45  $^{\circ}$  against perpendicular line.



## 6.2. Definition of applicable Zones



A Zone : Active display area

B Zone: Area from outside of "A Zone" to validity viewing area

C Zone: Rest parts

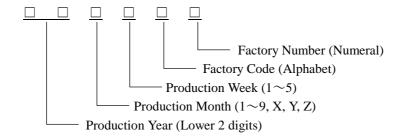
A Zone + B Zone = Validity viewing area

## 6.3.Standards

No.	Parameter			Criteria				
1	Black and	(1) Round Shape						
	White Spots,		Zone	Acceptable Number				
	Foreign Substances	Dimension (mm)		A	В	С		
		D ≦0.1		*	*	*		
		0.1 < D ≦0.2		3	5	*		
		0.2 < D ≦0.3		2	3	*		
		$0.3 < D \le 0.35$ $0.35 < D$ $D = (Long + Short) / 2$		0	1	*		
				0	0	*		
				* : Disregard				
		(2) Line Shape						
			Zone		Acceptable Number			
		X (mm) Y	/ (mm)	A	В	С		
			0.03≧W	*	*	*		
		2.0≧L	0.05≧W	4	4	*		
		1.0≧L	0.1 ≧W	4	4	*		
		_	0.1 < W	In	the same way	v (1)		
		X : Length Y : Width		*: Disregard				
		Total defects shall not exceed 7.						
2	Air Bubbles							
	(between glass		Zone	Acceptable Number				
	& polarizer)	Dimension (mm)		A	В	С		
	_	D1, D2≦0.3		*	*	*		
		0.3 <d1,< td=""><td colspan="2" rowspan="3"><math>0.3 &lt; D1, D2 \le 0.5</math> <math>0.5 &lt; D1 \le 0.7</math> <math>0.5 &lt; D2 \le 0.6</math></td><td>*</td><td>*</td></d1,<>	$0.3 < D1, D2 \le 0.5$ $0.5 < D1 \le 0.7$ $0.5 < D2 \le 0.6$		*	*		
		0.5< D			3	*		
		0.5< D			3	*		
		0.7 <d1, 0.6<d2<="" td=""><td>0</td><td>0</td><td>*</td></d1,>		0	0	*		
		D1 : Small foam a gatherin		ng D2 : Singl	le foam *	: Disregard		
		Total defects sha	ıll not exceed	5		_		
		However, each pixel shall remain more than one-third of the original						
3	The Shape of Dot	However, each p			one-third of	the original		
3	The Shape of Dot	However, each p pixel size.			one-third of	the original		
3	The Shape of Dot  Polarizer Scratches		ixel shall rem	ain more than	one-third of	the original		
	-	pixel size.	vixel shall rem	nain more than				
4	Polarizer Scratches	pixel size.  Not to be conspi	vixel shall rem	nain more than				
4	Polarizer Scratches	pixel size.  Not to be conspi  If the stains are r	cuous defects	ain more than . y from LCDP	surface, the n	nodule is not		
4 5	Polarizer Scratches Polarizer Dirts	pixel size.  Not to be conspi  If the stains are r defective.  Black spots, line	cuous defects removed easily	. y from LCDP gn substances	surface, the n	nodule is not		
4 5	Polarizer Scratches Polarizer Dirts  Complex Foreign	pixel size.  Not to be conspi  If the stains are r defective.	cuous defects removed easily shaped foreign	. y from LCDP gn substances	surface, the n	nodule is not		
5	Polarizer Scratches Polarizer Dirts  Complex Foreign Substance Defects	pixel size.  Not to be conspi  If the stains are r defective.  Black spots, line glass & polarizer	cuous defects removed easily shaped foreign r should be 7p or more	. y from LCDP gn substances	surface, the n	nodule is not		

# 7. Code System of Production Lot

The production lot of module is specified as follows.



## 8. Type Number

The type number of module is specified on the back of module as follows.

# 9. Applying Precautions

Please contact us when questions and/or new problems not specified in this specifications arise.

## 10. Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
  - ① The liquid crystal display device panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care.
  - ② The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.
- 2) Care of the liquid crystal display module against static electricity discharge.
  - ① When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats ( made of rubber ), to protect work tables against the hazards of electrical shock.
  - ② Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
  - ③ Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.
- 3) When the LCD module alone must be stored for long periods of time:
  - ① Protect the modules from high temperature and humidity.
  - ② Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
  - ③ Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- 5) Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conduc1tivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.
- 7) For models which use CFL:
  - ① High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
  - ② Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
  - The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.

- 8) For models which use touch panels:
  - ①Do not stack up modules since they can be damaged by components on neighboring modules.
  - ②Do not place heavy objects on top of the product. This could cause glass breakage.
- 9) For models which use COG, TAB, or COF:
  - ①The mechanical strength of the product is low since the IC chip faces out unprotected from the rear. Be sure to protect the rear of the IC chip from external forces.
  - ②Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.
- 10) Models which use flexible cable, heat seal, or TAB:
  - ①In order to maintain reliability, do not touch or hold by the connector area.
  - ②Avoid any bending, pulling, or other excessive force, which can result in broken connections.

### 11.Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- ① We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- ② We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- ③ We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- When the product is in CFL models, CFL service life and brightness will vary according to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- We cannot accept responsibility for industrial property, which may arise through the use of your product, with exception to those issues relating directly to the structure or method of manufacturing of our product.
- ⑥ Optrex will not be held responsible for any quality guarantee issue for defect products judged as Optrex-origin longer than 2 (two) years from Optrex production or 1(one) year from Optrex, Optrex America, Optrex Europe, Display LC delivery which ever comes later.